## Product Description

The BSW7321 is a reflective SPDT RF switch that can be used in high power and good performance WLAN $802.11 \mathrm{a} / \mathrm{b} / \mathrm{g} / \mathrm{n} / \mathrm{ac} / \mathrm{ax}$, DOCSIS 3.0/3.1 and Wireless Communication applications.
This device is packaged in RoHS2-compliant with $1.5 \mathrm{~mm} \times 1.5 \mathrm{~mm} \times 0.5 \mathrm{~mm}$, 6-Lead UDFN package. It must be used with back side ground soldering.
The BSW7321 has robust ESD protection circuits at all pins and temperature performance (operating temperature range : -40 to $+105^{\circ} \mathrm{C}$ ).
This switch does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor. This device also has a high linearity performance over all temperature range such as IIP3, IIP2.
A functional block diagram is shown in Figure 1.

## Block Diagram



Figure 1 Functional Block Diagram

## Applications

- WiMAX 802.16
- WLAN $802.11 \mathrm{a} / \mathrm{b} / \mathrm{g} / \mathrm{n} / \mathrm{ac} / \mathrm{ax}$
- DOCSIS 3.0/3.1
- Drone
- Bluetooth
- Wireless Infrastructure
- Remote keyless entry
- Telematics / Infotainment
- Two-way radios
- Wireless control systems
- GPS/Navigation


## Package Type


$1.5 \mathrm{~mm} \times 1.5 \mathrm{~mm} \times 0.5 \mathrm{~mm}$, 6-Lead UDFN Package Figure 2 Package Type

## Device Features

- Output frequency range : 5 MHz to 8.0 GHz
- Fast Switching Time : 105 to 145 ns
- Supply Voltage : 2.7 V to 3.6 V
- Low insertion loss
: 0.58dB @ 2.45 GHz
: $0.86 \mathrm{~dB} @ 5.75 \mathrm{GHz}$
- High isolation
: 43dB @ 2.45GHz
: 30dB @ 5.75GHz
- Input 1 dB output compression : 39dBm @ 2.45 GHz
: 39dBm @ 5.75 GHz
- High IIP3
: 65dBm @ 2.45 GHz
: 65dBm @ 5.75GHz
- ESD protection (HBM) : 2.0kV @ all pins
- 6-Lead UDFN package : $1.5 \mathrm{~mm} \times 1.5 \mathrm{~mm} \times 0.5 \mathrm{~mm}$
- Operating temperature range : $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
- Lead-free/RoHS2-compliant UDFN package

BSW7321

## Electrical Specifications

Typical conditions are at VDD $=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, $\mathrm{V} 1 \mathrm{Low}=0 \mathrm{~V}, \mathrm{~V} 1 \mathrm{High}=3.3 \mathrm{~V}, \mathrm{Z}_{\mathrm{L}}=50 \Omega$, Excluding SMA Connector and PCB loss ${ }^{(1)}$, unless otherwise noted.

Table 1 Electrical Specifications

| Parameter | Path | Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Frequency |  |  | 5 |  | 8000 | MHz |
| Insertion Loss | RFC - RFx | 1 GHz <br> 2GHz <br> 3GHz <br> 4GHz <br> 5 GHz <br> 6 GHz <br> 7GHz <br> 8GHz |  | $\begin{aligned} & 0.50 \\ & 0.57 \\ & 0.61 \\ & 0.59 \\ & 0.65 \\ & 0.97 \\ & 0.88 \\ & 0.96 \end{aligned}$ |  | dB |
| Isolation | RFC - RFx | 1 GHz <br> 2GHz <br> 3 GHz <br> 4 GHz <br> 5 GHz <br> 6 GHz <br> 7GHz <br> 8GHz |  | $\begin{aligned} & 52 \\ & 46 \\ & 30 \\ & 35 \\ & 32 \\ & 30 \\ & 29 \\ & 26 \end{aligned}$ |  | dB |
| Isolation | RFx - RFx | 1 GHz <br> 2GHz <br> 3 GHz <br> 4GHz <br> 5 GHz <br> 6 GHz <br> 7GHz <br> 8GHz |  | $\begin{aligned} & 44 \\ & 36 \\ & 33 \\ & 30 \\ & 29 \\ & 26 \\ & 25 \\ & 23 \end{aligned}$ |  | dB |
| Return Loss | RFC, RF1, RF2 | $5 \mathrm{MHz}-8 \mathrm{GHz}$ (Active port) |  | 15 |  | dB |
| Input P1dB | RFC - RFx | $\begin{aligned} & 2.45 \mathrm{GHz} \\ & 5.75 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & 39 \\ & 39 \end{aligned}$ |  | dBm |
| Input IP3 ${ }^{(2)}$ | RFC - RFx | $\begin{aligned} & 2.45 \mathrm{GHz} \\ & 5.75 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & 65 \\ & 65 \\ & \hline \end{aligned}$ |  | dBm |
| Input IP2 ${ }^{(2)}$ | RFC - RFx | $\begin{aligned} & 2.45 \mathrm{GHz} \\ & 5.75 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & \hline 100 \\ & 100 \\ & \hline \end{aligned}$ |  | dBm |
| $2^{\text {nd }}$ Harmonic ${ }^{(3)}$ | RFC - RFx | $\begin{aligned} & 2.45 \mathrm{GHz} \\ & 5.75 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & 90 \\ & 90 \\ & \hline \end{aligned}$ |  | dBc |
| $3^{\text {rd }}$ Harmonic ${ }^{(3)}$ | RFC - RFx | $\begin{aligned} & 2.45 \mathrm{GHz} \\ & 5.75 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & 105 \\ & 105 \\ & \hline \end{aligned}$ |  | dBc |
| Switching Time | RFC - RFx | 50\% control to 90\% RF 50\% control to $10 \%$ RF |  | $\begin{aligned} & 145 \\ & 105 \end{aligned}$ |  | ns |
| Settling Time | RFC - RFx | $50 \%$ CTRL to 0.05 dB final value Rising Edge $50 \%$ CTRL to 0.05 dB final value Falling Edge |  | $\begin{aligned} & 155 \\ & 115 \\ & \hline \end{aligned}$ |  | ns |

The typical spurious performance of the BSW7321 is $-115 \mathrm{dBm} / 10 \mathrm{~Hz}$ @ Over 10 MHz
(1) Excluding SMA Connector and PCB loss.
$1 \mathrm{GHz}(0.14 \mathrm{~dB}), 2 \mathrm{GHz}(0.22 \mathrm{~dB}), 3 \mathrm{GHz}(0.27 \mathrm{~dB}), 4 \mathrm{GHz}(0.36 \mathrm{~dB}), 5 \mathrm{GHz}(0.41 \mathrm{~dB}), 6 \mathrm{GHz}(0.45 \mathrm{~dB}), 7 \mathrm{GHz}(0.59 \mathrm{~dB}), 8 \mathrm{GHz}(0.64 \mathrm{~dB})$
(2) The two-tone Power is 18 dBm each and Tone spacing is 20 KHz .
(3) Tone Power is 18 dBm .

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## Product Description



Figure 3 Functional Block Diagram

Table 2 Pin Descriptions

| No. | Pin Name | Descriptions |
| :---: | :---: | :---: |
| 1 | V1 | Digital Control Logic Input |
| 2 | RFC | RF Common port |
| 3 | VDD | Supply Voltage |
| 4 | RF2 | RF2 port |
| 5 | GND | Ground |
| 6 | RF1 | RF1 port |
| Pad | Exposed Pad | Ground |

Table 3 V1 Control Truth Table

| V1 | RFC-RF1 | RFC-RF2 |
| :---: | :---: | :---: |
| 0 | OFF | ON |
| 1 | ON | OFF |

Table 4 Recommended Operating Conditions*

| Parameter | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | VDD | 2.7 | 3.3 | 3.6 | V |
| Supply Current | IDD | - | 170 | - | $\mu \mathrm{A}$ |
| Digital Input Control (V1) | V1 High | 1.0 | - | 3.3 | V |
|  | V1 Low | 0 | - | 0.7 | V |
| Operating Temperature Range | To | -40 | +25 | +105 | ${ }^{\circ} \mathrm{C}$ |
| RF Input Power, CW Freq. $=2.45 \mathrm{GHz}, 5.75 \mathrm{GHz}$ Any port, $\mathrm{Z}_{\mathrm{L}}=50 \Omega$ | - | - | - | 30 | dBm |

*Specifications are not guaranteed over all recommended operating conditions.

Table 5 Absolute Maximum Ratings

| Parameter |  |  | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage |  |  | VDD | -0.3 | 3.6 | V |
| Digital Input Voltage (V1) |  |  | V1 | -0.3 | 3.6 | V |
| Maximum Input Power, CW ( $+25^{\circ} \mathrm{C}$ ) |  |  | - | - | Input P1dB | dBm |
| Storage Temperature range |  |  | - | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| ESD | HBM | All pins | - | - | 2000 | V |
|  | CDM | All pins | - | - | 1000 | V |

## Typical Performances

Typical conditions are at $\mathrm{VDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V} 1 \mathrm{Low}=0 \mathrm{~V}, \mathrm{~V} 1$ High $=3.3 \mathrm{~V}, \mathrm{Z}_{\mathrm{L}}=50 \Omega$, Excluding SMA Connector and PCB loss, unless otherwise noted.

Figure 4 Insertion Loss vs. Vdd (RFC - RFx)


Figure 6 Return Loss (RFC, RFx)


Figure 5 Insertion Loss vs. Temp (RFC - RFx)


Figure 7 Return Loss vs. Temp (RFC)


## Typical Performances

Typical conditions are at $\mathrm{VDD}=3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V} 1 \mathrm{Low}=0 \mathrm{~V}, \mathrm{~V} 1$ High $=3.3 \mathrm{~V}, \mathrm{Z}_{\mathrm{L}}=50 \Omega$, Excluding SMA Connector and PCB loss, unless otherwise noted.

Figure $\mathbf{8}$ Isolation vs. Vdd (RFC - RFx)


Figure 10 Isolation vs. Vdd (RFx - RFx)


Figure 9 Isolation vs. Temp (RFC-RFx)


Figure 11 Isolation vs. Temp (RFx - RFx)


## Evaluation Board



Figure 12 Evaluation Board Layout


Figure 13 Evaluation Board Schematic


Figure 14 Evaluation Board PCB Layer Information

| No. | Ref Des | Part Qty | Part Number | Remark |
| :---: | :---: | :---: | :---: | :---: |
| 1 | C1 | 1 | CAP 1005 1uF J 50V |  |
| 2 | C2,C3* | 2 | CAP 1005 100pF J 50V |  |
| 3 | C4 | 2 | CAP 1005 DNI |  |
| 4 | C5 | 1 | CAP 0603 DNI |  |
| 6 | J1,J2 | 2 | 2 Pin Header |  |
| 7 | RFC, RF1, RF2 | 3 | SMA_END_LAUNCH |  |
| 8 | U1 | 1 | BSW7321 |  |

* C3 should be placed near the device.


## Package Outline Drawing

TDP VIEW


Pin 1 index area


SIDE VIEW

NOTES:

1. Dimension and tolerancing contorm to ASME Y $14.5 \mathrm{M}-1994$.
2. Contrilling Dimensions: Millimeter, Converted INCH dimension are not necessarily exact.
3. Dimension b applied to Metallized terminal ond is measured between 0.15 to 0.30 mm from terminal tip.

BOTTDM VIEW


| $\begin{aligned} & S \\ & \mathrm{Y} \\ & \mathrm{M} \\ & \mathrm{~B} \\ & \mathrm{~B} \end{aligned}$ | Common |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | dimensions millimeter |  |  | DIMENSİNS INCH |  |  |
|  | MIN, | NDM. | MAX ${ }_{\text {i }}$ | MIN, | NDM, | MAX, |
| A | 0.45 | 0.50 | 0.55 | 0.018 | 0.020 | 0.022 |
| A3 | 0.127 REF. |  |  | 0.005 REF. |  |  |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| b | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 |
| D | 1.45 | 1.50 | 1.55 | 0.057 | 0.059 | 0.061 |
| D2 | 1.15 | 1.20 | 1.25 | 0.045 | 0,047 | 0,049 |
| E | 1.45 | 1.50 | 1.55 | 0.057 | 0,059 | 0,061 |
| E2 | 0.65 | 0.70 | 0.75 | 0.026 | 0,028 | 0.030 |
| e |  | 00 BS |  |  | 20 BS |  |
| L | 0,125 | 0.175 | 0.225 | 0.005 | 0,007 | 0.009 |
| K | 0.230 | - | - | 0,009 | - | - |

Figure 15 Package Outline Drawing


Figure 16 Recommended Land Pattern

BSW7321

## Tape \& Reel




| Packaging information: |  |
| :--- | :--- |
| Tape Width | 8 mm |
| Reel Size | 7inch |
| Device Cavity Pitch | 4 mm |
| Device Per Reel | 3000 EA |

Figure 17 Tape \& Reel

## Package Marking



| Marking information: |  |  |  |
| :---: | :--- | :---: | :--- |
| Marking Code 1 |  | Marking Code 2 |  |
| S | RF Switch | 2 | The number of switch throw |
| 2 | The number of switch throw | D | Sequential Number |
| D | Sequential Number | XX | Wafer Lot Number |
| Y | Work Year |  |  |
| XX | Wafer Lot Number |  |  |

Figure 18 Package Marking

## Lead plating finish

## 100\% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C , Anneal bake to eliminate thin whisker growth concerns.)

## MSL / ESD Rating

| ESD information: |  |
| :--- | :--- |
| Rating | Class 2 (2000V) |
| Test | Human Body Model (HBM) |
| Standard | JS-001-2017 |


| MSL information: |  |
| :--- | :--- |
| Rating | Level 1 at $+260^{\circ} \mathrm{C}$ convection reflow |
| Standard | JEDEC Standard J-STD-020 |

## RoHS Compliance

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than $0.1 \%(w / w)$ in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

## NATO CAGE code:

| 2 | N | 9 | 6 | F |
| :--- | :--- | :--- | :--- | :--- |

